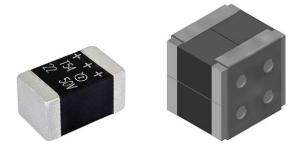


Vishay

vPolyTanTM Polymer Surface-Mount Chip Capacitors, Low ESR, Leadframeless Molded Type, Hi-Rel Commercial Off-The-Shelf (COTS)



LINKS TO ADDITIONAL RESOURCES







PERFORMANCE / ELECTRICAL CHARACTERISTICS

Operating Temperature: -55 °C to +125 °C (above 105 °C, additional voltage derating is required)

Capacitance Range:

15 μF to 470 μF (discrete capacitors) 30 μF to 2800 μF (stacked capacitors) Capacitance Tolerance: \pm 20 %

Voltage Rating: 16 V_{DC} to 75 V_{DC}

FEATURES

- Ultra low ESR
- High reliability processing including:
 - 100 % surge current tested
 - Accelerated voltage conditioning
 - Thermal shock
 - Statistical DC leakage screening at elevated temperature and voltage, covered by U.S. patent and worldwide patents pending. PATENT(S): www.vishay.com/patents/



- High ripple current capability
- Stable capacitance over operating temperature, voltage, and frequency range
- No wear out effect
- Molded case 7343 EIA size and stacks
 The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595
- Terminations: wraparound (for EE case)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Decoupling, smoothing, filtering
- Switch mode and point of load power supply
- Infrastructure equipment
- · Storage and networking

ORD	ERING	INFORMAT	ION					
T54	EE	457	М	030	E ⁽¹⁾	Z	Α	025
TYPE	CASE CODE	CAPACITANCE	CAPACITANCE TOLERANCE	DC VOLTAGE RATING	TERMINATION / PACKAGING	RELIABILITY LEVEL	SURGE CURRENT LEVEL	ESR
	EE, E2, E3, E4, E6 See Ratings and Case Codes tables.	This is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow.	M = ± 20 %	This is expressed in volts. To complete the three-digit block, zeros precede the voltage rating. A decimal point is indicated by an "R" (6R3 = 6.3 V)	B = 100 % tin / bulk in formed tray	Z = non- established reliability	A = 10 cycles at +25 °C and DCL screening at elevated temperature / voltage B = 10 cycles at -55 °C / +85 °C and DCL screening at elevated temperature / voltage S = 6 cycles at +25 °C and DCL screening at elevated temperature / voltage D = 10 cycles at +25 °C E = 10 cycles at -55 °C / +85 °C F = 6 cycles at +25 °C	Maximum 100 kHz ESR in mΩ

Note

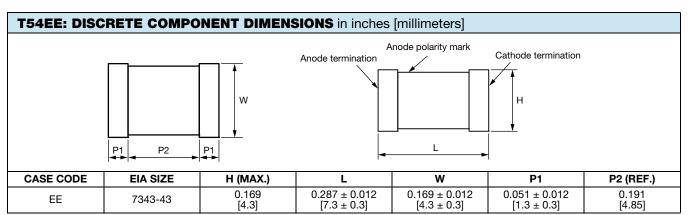
(1) Tape and reel is available for discrete capacitors (T54EE) only. Stacked capacitors (T54Ex) are shipped in formed trays. Contact factory for stack capacitors packing options

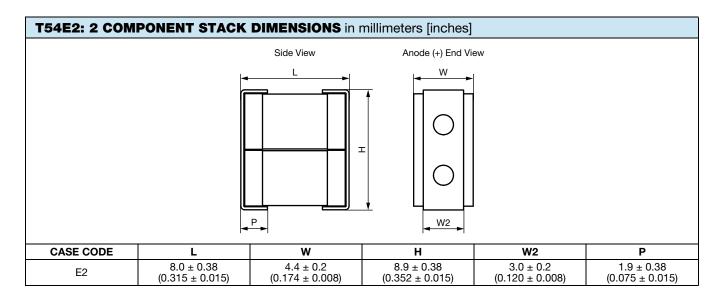
PATENT(S): www.vishay.com/patents

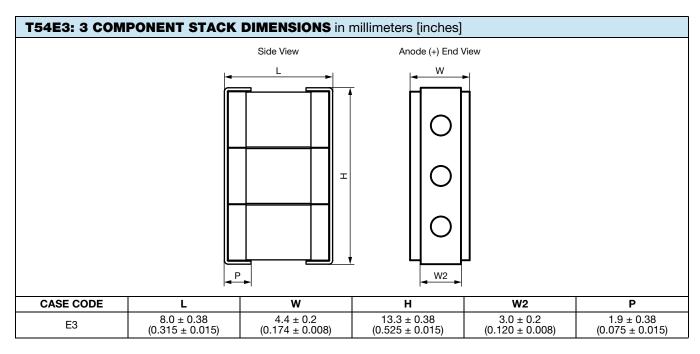
Revision: 08-Dec-2021

This Vishay product is protected by one or more United States and international patents.



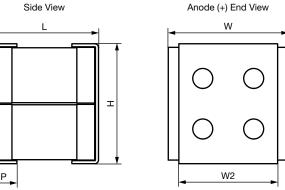




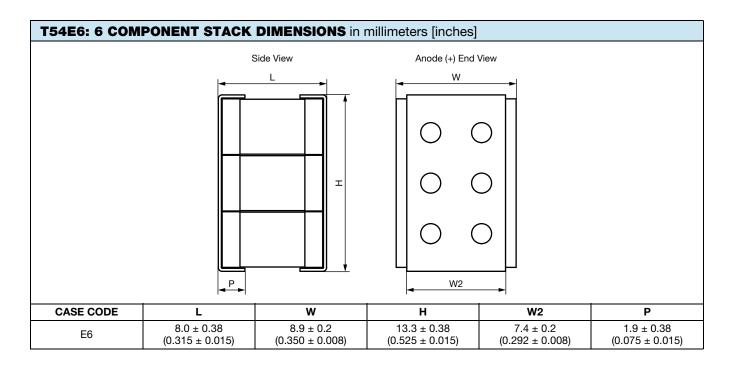




T54E4: 4 COMPONENT STACK DIMENSIONS in millimeters [inches]



			4		
CASE CODE	L	W	Н	W2	P
E4	8.0 ± 0.38 (0.315 ± 0.015)	8.9 ± 0.2 (0.350 ± 0.008)	8.9 ± 0.38 (0.352 ± 0.015)	7.4 ± 0.2 (0.292 ± 0.008)	1.9 ± 0.38 (0.075 ± 0.015)



T54EE: RATI	T54EE: RATINGS AND CASE CODES (ESR $m\Omega$)							
μF	16 V	30 V	35 V	50 V	63 V	75 V		
15					EE (100)	EE (100)		
22				EE (100)	EE (100)	EE (100)		
47			EE (70)	EE (100, 70)				
150		EE (150, 75)						
220	EE (25)							
330	EE (25)							
470	EE (25)							

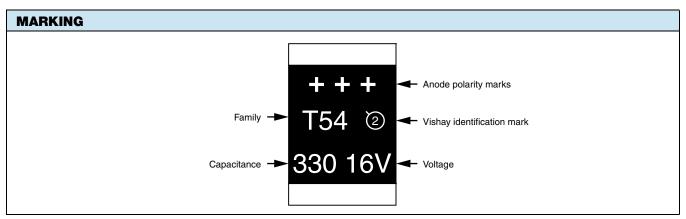
Note

⁽¹⁾ Rating in development: preliminary rating and electrical values. Contact factory for availability

μF	RATINGS AND C	30 V	35 V	50 V	63 V	75 V
	10 V	30 V	35 V	50 V		
30					E2 (50)	E2 (50)
45				E2 (50)	E2 (50) E3 (35)	E2 (50) E3 (35)
60					E4 (25)	E4 (25)
66				E3 (35)	E3 (35)	E3 (35)
90				E4 (25)	E4 (25) E6 (17)	E4 (25) E6 (17)
95			E2 (35/28)	E2 (50)		
130				E6 (17)	E6 (17)	E6 (17)
140			E3 (25/18)	E3 (35)		
190			E4 (18/14)	E4 (25)		
280			E6 (12/10)	E6 (17)		
300		E2 (75, 38)				
450	E2 (13)	E3 (50, 25)				
600		E4 (38, 20)				
660	E2 (13) E3 (9)					
900	E4 (7)	E6 (25, 13)				
940	E2 (13, 10)					
990	E3 (9)					
1300	E4 (7) E6 (5)					
1400	E3 (9, 7)					
1900	E4 (7, 5)					
2000	E6 (5)					
2800	E6 (5)					

Note

⁽¹⁾ Contact marketing for availability of stacked capacitors



Note

· Marking shows discrete capacitor rating

T54EE: DIS	CRET	E COMPONENT STA	NDARD R	ATINGS					
CAPACITANCE	CASE		MAX. DCL	MAX. DF AT +25 °C	MAX. ESR AT +25 °C	MAX. RIPPLE,	HI TEMPERAT LOAD	URE	
(μF)	CODE	PART NUMBER	AT +25 °C (μA)	120 Hz (%)	100 kHz (mΩ)	100 kHz I _{RMS} (A)	TEMPERATURE (°C)	TIME (h)	MSL
		16 \	/ _{DC} AT +105	°C, 10 V _{DC} A	T 125 °C				
220	EE	T54EE227M016(1)(2)(3)025	352	10	25	4.195	125	2000	3
330	EE	T54EE337M016(1)(2)(3)025	528	10	25	4.195	125	2000	3
470	EE	T54EE477M016(1)(2)(3)025	752	10	25	4.195	125	2000	3
		30 \	/ _{DC} AT +105	°C, 20 V _{DC} A	T 125 °C				
150	EE	T54EE157M030(1)(2)(3)150	450	10	150	1.713	125	2000	3
150	EE	T54EE157M030(1)(2)(3)075	450	10	75	2.422	125	2000	3
		35 \	/ _{DC} AT +105	°C, 23 V _{DC} A	T 125 °C				
47	EE	T54EE476M035(1)(2)(3)070	165	10	70	2.507	125	2000	3
		50 \	/ _{DC} AT +105	°C, 33 V _{DC} A	T 125 °C				
22	EE	T54EE226M050(1)(2)(3)100	110	10	100	2.098	125	2000	3
47	EE	T54EE476M050(1)(2)(3)100	235	10	100	2.098	125	2000	3
47	EE	T54EE476M050(1)(2)(3)070	235	10	70	2.507	125	2000	3
		63 \	/ _{DC} AT +105	°C, 42 V _{DC} A	T 125 °C				
15	EE	T54EE156M063(1)(2)(3)100	95	10	100	2.098	125	2000	3
22	EE	T54EE226M063(1)(2)(3)100	139	10	100	2.098	125	2000	3
	75 V _{DC} AT +105 °C, 50 V _{DC} AT 125 °C								
15	EE	T54EE156M075(1)(2)(3)100	113	10	100	2.098	125	1000	3
22	EE (2)	T54EE226M075(1)(2)(3)100	165	12	100	2.098	125	1000	3

Notes

- Part number definitions:
 - (1) Termination and packaging: E, L, C, H, B, V

 - (2) Reliability level: Z, S (3) Surge current: A, B, S, D, E, F
- (1) Rating in development: preliminary rating and electrical values. Contact factory for availability
- Surge voltage test conditions: 85 °C, 1000 successive test cycles at 1.3 of rated voltage in series with a 33 Ω resistor at the rate of 30 s ON, 30 s OFF

T54Ex: CO	T54Ex: COMPONENT STACK STANDARD RATINGS (1)								
CAPACITANCE	CITANCE CASE DADT NUMBER MAX. DCL MAX. DF MAX. ESR		NIPPLE,	RIPPLE, LOAD		1401			
(μF)	CODE	PART NUMBER	AT +25 °C (μΑ)	120 Hz (%)	100 kHz (mΩ)	100 kHz I _{RMS} (A)	TEMPERATURE (°C)	TIME (h)	MSL
		16 \	/ _{DC} AT +105	°C, 10 V _{DC} A	T 125 °C				
450	E2	T54E2457M016(1)(2)(3)013	704	10	13	6.794	125	2000	3
660	E2	T54E2667M016(1)(2)(3)013	1056	10	13	6.794	125	2000	3
660	E3	T54E3667M016(1)(2)(3)009	1056	10	9	8.165	125	2000	3
880	E4	T54E4887M016(1)(2)(3)007	1408	10	7	9.258	125	2000	3
940	E2	T54E2947M016(1)(2)(3)013	1504	10	13	6.794	125	1000	3
940	E2	T54E2947M016(1)(2)(3)010	1504	10	10	7.746	125	1000	3
990	E3	T54E3997M016(1)(2)(3)009	1584	10	9	8.165	125	2000	3
1300	E4	T54E4138M016(1)(2)(3)007	2112	10	7	9.258	125	2000	3
1300	E6	T54E6138M016(1)(2)(3)005	2112	10	5	10.954	125	2000	3
1400	E3	T54E3148M016(1)(2)(3)009	2256	10	9	8.165	125	1000	3
1400	E3	T54E3148M016(1)(2)(3)007	2256	10	7	9.258	125	1000	3
1900	E4	T54E4198M016(1)(2)(3)007	3008	10	7	9.258	125	1000	3
1900	E4	T54E4198M016(1)(2)(3)005	3008	10	5	10.954	125	1000	3
2000	E6	T54E6208M016(1)(2)(3)005	3168	10	5	10.954	125	2000	3
2800	E6	T54E6288M016(1)(2)(3)005	4512	10	5	10.954	125	1000	3

- Part number definitions:
 - (1) Termination and packaging: E, L, C, H, B, V. Contact factory for packing options (2) Reliability level: Z, S

 - (3) Surge current: A, B, S, D, E, F
- (1) Contact marketing for availability of stacked capacitors
- (2) Rating in development: preliminary rating and electrical values. Contact factory for availability

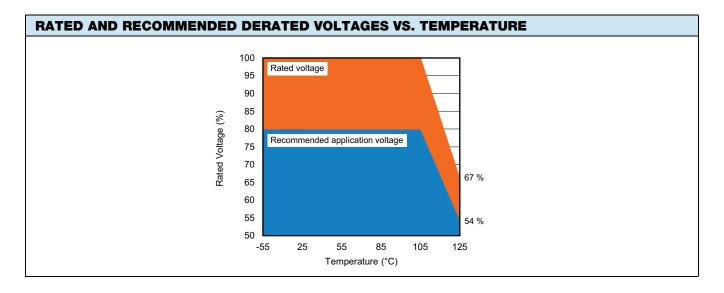


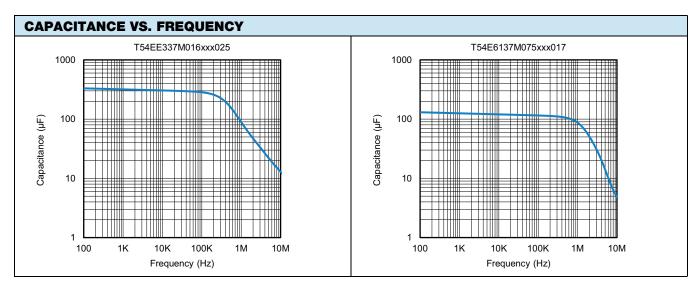
T54Ex: CO	MPON	ENT STACK STAND	ARD RATI	NGS ⁽¹⁾					
CAPACITANCE		PART NUMBER	MAX. DCL	MAX. DF AT +25 °C 120 Hz	MAX. ESR AT +25 °C 100 kHz	MAX. RIPPLE, 100 kHz	HI TEMPERAT LOAD	URE	MSL
(μF)	CODE	PART NOMBER	AT +25 °C (μA)	120 Hz (%)	100 kHz (mΩ)	I _{RMS}	TEMPERATURE (°C)	TIME (h)	WISE
		30 \	/ _{DC} AT +105	°C, 20 V _{DC} A	T 125 °C				
300	E2	T54E2307M030(1)(2)(3)075	900	10	75	2.828	125	2000	3
300	E2	T54E2307M030(1)(2)(3)038	900	10	38	3.974	125	2000	3
450	E3	T54E3457M030(1)(2)(3)050	1350	10	50	3.464	125	2000	3
450	E3	T54E3457M030(1)(2)(3)025	1350	10	25	4.899	125	2000	3
600	E4	T54E4607M030(1)(2)(3)038	1800	10	38	3.974	125	2000	3
600	E4	T54E4607M030(1)(2)(3)020	1800	10	20	5.477	125	2000	3
900	E6	T54E6907M030(1)(2)(3)025	2700	10	25	4.899	125	2000	3
900	E6	T54E6907M030(1)(2)(3)013	2700	10	13	6.794	125	2000	3
		35 \	/ _{DC} AT +105	°C, 25 V _{DC} A	T 125 °C				•
95	E2	T54E2956M035(1)(2)(3)035	330	10	35	4.140	125	2000	3
95	E2	T54E2956M035(1)(2)(3)028	330	10	28	4.629	125	2000	3
140	E3	T54E3147M035(1)(2)(3)025	495	10	25	4.899	125	2000	3
140	E3	T54E3147M035(1)(2)(3)018	495	10	18	5.774	125	2000	3
190	E4	T54E4197M035(1)(2)(3)018	660	10	18	5.774	125	2000	3
190	E4	T54E4197M035(1)(2)(3)014	660	10	14	6.547	125	2000	3
280	E6	T54E6287M035(1)(2)(3)012	990	10	12	7.071	125	2000	3
280	E6	T54E6287M035(1)(2)(3)010	990	10	10	7.746	125	2000	3
		50 \	/ _{DC} AT +105	°C, 33 V _{DC} A	T 125 °C				
45	E2	T54E2456M050(1)(2)(3)050	220	10	50	3.464	125	1000	3
66	E3	T54E3666M050(1)(2)(3)035	330	10	35	4.140	125	1000	3
95	E2	T54E2956M050(1)(2)(3)050	470	10	50	3.464	125	1000	3
90	E4	T54E4906M050(1)(2)(3)025	440	10	25	4.899	125	1000	3
130	E6	T54E6137M050(1)(2)(3)017	660	10	17	5.941	125	1000	3
140	E3	T54E3147M050(1)(2)(3)035	705	10	35	4.140	125	1000	3
190	E4	T54E4197M050(1)(2)(3)025	940	10	25	4.899	125	1000	3
280	E6	T54E6287M050(1)(2)(3)017	1410	10	17	5.941	125	1000	3
		63 \	/ _{DC} AT +105	°C, 43 V _{DC} A	T 125 °C				
30	E2	T54E2306M063(1)(2)(3)050	190	10	50	3.464	125	1000	3
45	E2	T54E2456M063(1)(2)(3)050	278	10	50	3.464	125	1000	3
45	E3	T54E3456M063(1)(2)(3)035	285	10	35	4.140	125	1000	3
60	E4	T54E4606M063(1)(2)(3)025	380	10	25	4.899	125	1000	3
66	E3	T54E3666M063(1)(2)(3)035	417	10	35	4.140	125	1000	3
90	E4	T54E4906M063(1)(2)(3)025	556	10	25	4.899	125	1000	3
90	E6	T54E6906M063(1)(2)(3)017	570	10	17	5.941	125	1000	3
130	E6	T54E6137M063(1)(2)(3)017	834	10	17	5.941	125	1000	3
		75 \	/ _{DC} AT +105	°C, 50 V _{DC} A	T 125 °C				
30	E2 (2)	T54E2306M075(1)(2)(3)050	226	10	50	3.464	125	1000	3
45	E2 (2)	T54E2456M075(1)(2)(3)050	330	12	50	3.464	125	1000	3
45	E3 ⁽²⁾	T54E3456M075(1)(2)(3)035	339	10	35	4.140	125	1000	3
60	E4 (2)	T54E4606M075(1)(2)(3)025	452	10	25	4.899	125	1000	3
66	E3 ⁽²⁾	T54E3666M075(1)(2)(3)035	495	12	35	4.140	125	1000	3
90	E4 (2)	T54E4906M075(1)(2)(3)025	660	12	25	4.899	125	1000	3
90	E6 ⁽²⁾	T54E6906M075(1)(2)(3)017	678	10	17	5.941	125	1000	3
130	E6 ⁽²⁾	T54E6137M075(1)(2)(3)017	990	12	17	5.941	125	1000	3
Notes									

- Part number definitions:
 - (1) Termination and packaging: E, L, C, H, B, V. Contact factory for packing options (2) Reliability level: Z, S
- (3) Surge current: A, B, S, D, E, F

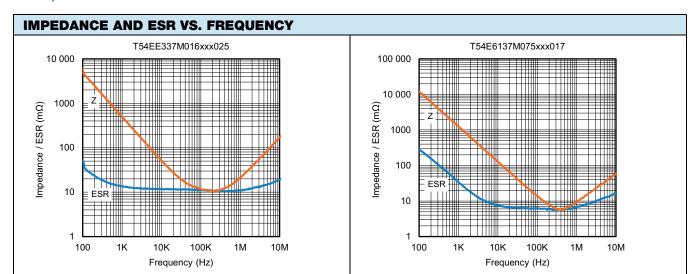
 (1) Contact marketing for availability of stacked capacitors
- (2) Rating in development: preliminary rating and electrical values. Contact factory for availability

RECOMMENDED VOLT	RECOMMENDED VOLTAGE DERATING GUIDELINES						
CAPACITOR VOLTAGE RATING AT -55 °C TO +105 °C	CAPACITOR CATEGORY VOLTAGE AT +105 °C TO +125 °C	RECOMMENDED VOLTAGE DERATING AT -55 °C TO +105 °C	RECOMMENDED VOLTAGE DERATING AT +105 °C TO +125 °C				
16	10	12.8	8.6				
30	20	24	16.2				
35	23	28	18.4				
50	33	40	26.4				
63	42	50	34				
75	50	60	40.5				









POWER DISSIPATIO	POWER DISSIPATION						
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION AT +45 °C (W) WITH +30 °C RISE IN FREE AIR						
EE	0.44						
E2, E3, E4, E6	0.60						

STANDARD PACKAGING QUANTITY					
CASE CODE	QUANTITY (PCS/PACKAGING UNIT)				
CASE CODE	7" REEL	½ REEL			
EE	400	200			

Note

Contact factory for stack capacitors packing and board mounting options

PERFORMANCI	PERFORMANCE CHARACTERISTICS (for Discrete Capacitors T54EE)					
ITEM	CONDITION	POST TEST PERFORMANCE				
Life test at +105 °C	2000 h application of rated voltage at 105 °C, MIL-STD-202 method 108	Capacitance change	Within ± 20 % of initial value			
	MIL-STD-202 method 108	Dissipation factor	Within initial limits			
		Leakage current	Shall not exceed 300 % of initial limit			
Life test at +125 °C			Within ± 20 % of initial value			
	MIL-STD-202 method 108	Dissipation factor	Within initial limits			
		Leakage current	Shall not exceed 300 % of initial limit			
Shelf life test	2000 h no voltage applied at 105 °C, MIL-STD-202 method 108	Capacitance change	Within ± 20 % of initial value			
at +105 °C	MIL-S1D-202 method 108	Dissipation factor	Within initial limits			
		Leakage current	Shall not exceed 300 % of initial limit			
Humidity tests	At 60 °C / 90 % RH 500 h, no voltage applied	Capacitance change	-20 % to +40 % of initial value			
		Dissipation factor	Within initial limit			
		Leakage current	Shall not exceed 300 % of initial limit			



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PERFORMANC	E CHARACTERISTICS (for Discrete Cap	pacitors T54EE)		
ITEM	CONDITION	POST TEST PERFORMANCE		
Stability at low and	-55 °C	Capacitance change	Within -20 % to 0 % of initial value	
high temperatures		Dissipation factor	Shall not exceed 150 % of initial limit	
		Leakage current	n/a	
	25 °C	Capacitance change	Within ± 20 % of initial value	
		Dissipation factor	Within initial limit	
		Leakage current	Within initial limit	
	85 °C	Capacitance change	Within -0 % to +50 % of initial value	
		Dissipation factor	Within initial limit	
		Leakage current	Shall not exceed 1000 % of initial value	
	105 °C	Capacitance change	Within -0 % to +50 % of initial value	
		Dissipation factor	Within initial limit	
		Leakage current	Shall not exceed 1000 % of initial limit	
Surge voltage	105 °C, 1000 successive test cycles at 1.3 of	Capacitance change	Within ± 20 % of initial value	
	rated voltage in series with a 33 Ω resistor at the rate of 30 s ON, 30 s OFF	Dissipation factor	Within initial limit	
	110 1410 01 00 3 014, 00 3 011	Leakage current	Shall not exceed 300 % of initial limit	

PERFORMANCE CHARACTERISTICS (for Discrete Capacitors T54EE and Component Stacks)				
ITEM	CONDITION	POST TEST PERFORMANCE		
Shock	MIL-STD-202, method 213, condition E,	Capacitance change	Within ± 20 % of initial value	
(specified pulse)	1000 <i>g</i> peak	Dissipation factor	Within initial limit	
		Leakage current	Shall not exceed 300 % of initial limit	
	ibration MIL-STD-202, method 204, condition D, 10 Hz to 2000 Hz 20 g peak	Capacitance change	Within ± 20 % of initial value	
		Dissipation factor	Within initial limit	
		Leakage current	Shall not exceed 300 % of initial limit	
		There shall be no mechanical or visual damage to capacitors post-conditioning.		
Shear test	Shear test Apply a pressure load of 17.7 N for 10 s ± 1 s horizontally to the center of capacitor side body		Within ± 20 % of initial value	
	horizontally to the center of capacitor side body	Dissipation factor	Within initial limit	
		Leakage current	Shall not exceed 300 % of initial limit	

PRODUCT INFORMATION			
Polymer Guide	www.vishay.com/doc?40076		
Moisture Sensitivity	www.vishay.com/doc?40135		
Infographic	www.vishay.com/doc?48084		
Sample Board	www.vishay.com/doc?48073		
FAQ			
Frequently Asked Questions	www.vishay.com/doc?42106		



Guide for Tantalum Solid Electrolyte Chip Capacitors With Polymer Cathode

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum/tantalum oxide/manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance/volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance/volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS				
DIELECTRIC	e DIELECTRIC CONSTANT			
Air or vacuum	1.0			
Paper	2.0 to 6.0			
Plastic	2.1 to 6.0			
Mineral oil	2.2 to 2.3			
Silicone oil	2.7 to 2.8			
Quartz	3.8 to 4.4			
Glass	4.8 to 8.0			
Porcelain	5.1 to 5.9			
Mica	5.4 to 8.7			
Aluminum oxide	8.4			
Tantalum pentoxide	26			
Ceramic	12 to 400K			

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

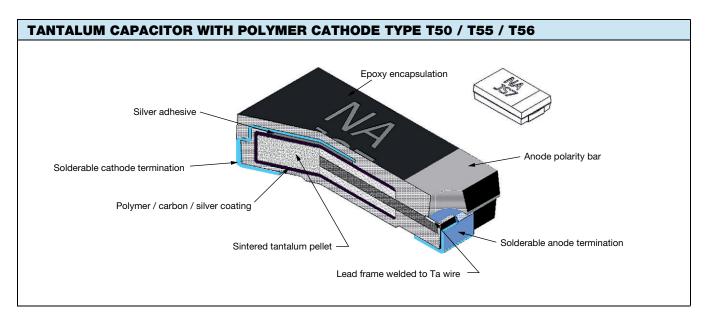


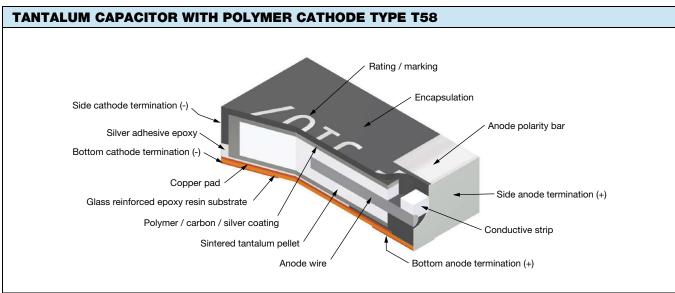
SOLID ELECTROLYTE POLYMER TANTALUM CAPACITORS

Solid electrolyte polymer capacitors utilize sintered tantalum pellets as anodes. Tantalum pentoxide dielectric layer is formed on the entire surface of anode, which is further impregnated with highly conductive polymer as cathode system.

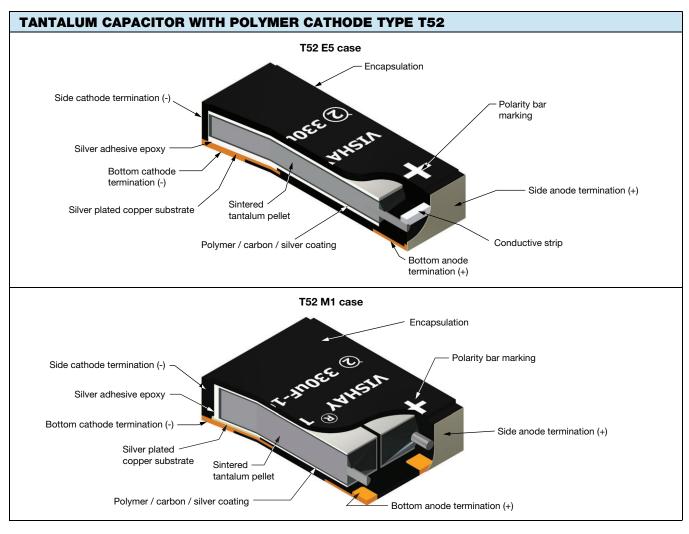
The conductive polymer layer is then coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the capacitor element and the outer termination (lead frame or other).

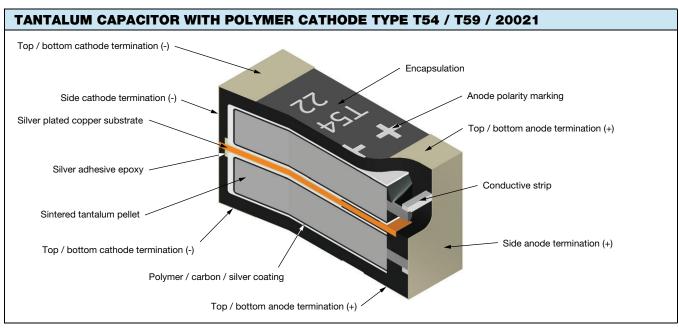
Molded chip polymer tantalum capacitor encases the element in plastic resins, such as epoxy materials. The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for variety of applications in electronic devices. Usage of conductive polymer cathode system provides very low equivalent series resistance (ESR), which makes the capacitors particularly suitable for high frequency applications.



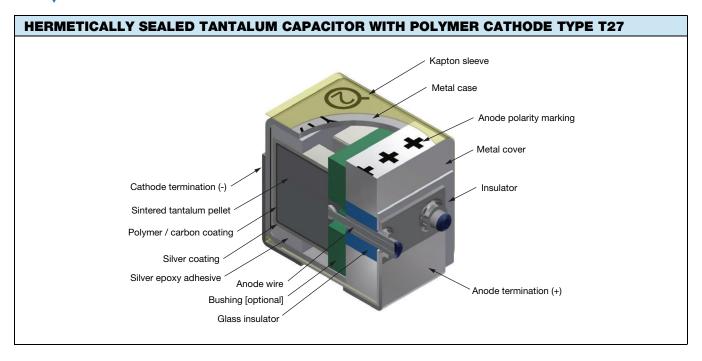












POLYMER CAPACITORS - METAL CASE, HERMETICALLY SEALED				
SERIES	T27			
PRODUCT IMAGE				
ТҮРЕ	VPolyTan TM hermetically sealed polymer surface-mount chip capacitors, low ESR			
FEATURES	Hermetically sealed in metal case, low ESR / low DCL, hi-rel. processing			
TEMPERATURE RANGE	-55 °C to +125 °C			
CAPACITANCE RANGE	15 μF to 470 μF			
VOLTAGE RANGE	16 V to 75 V			
CAPACITANCE TOLERANCE	± 20 %			
LEAKAGE CURRENT	0.05 CV			
DISSIPATION FACTOR	12 %			
ESR	25 m Ω to 100 m Ω			
CASE SIZES	D			
TERMINATION FINISH	100 % tin; tin / lead			

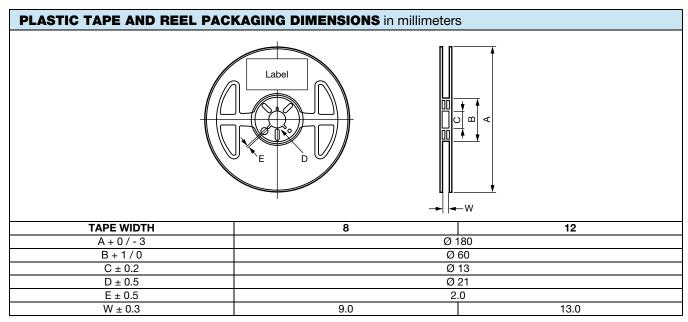


POLYMER CAPACITORS - MOLDED CASE					
SERIES	T50, T55, T56				
PRODUCT IMAGE	THE REAL PROPERTY OF THE PARTY				
TYPE	VPolyTan TM , molded case, high performance polymer				
FEATURES	High performance				
TEMPERATURE RANGE	-55 °C to +105 °C / +125 °C				
CAPACITANCE RANGE	3.3 μF to 1000 μF				
VOLTAGE RANGE	2.5 V to 63 V				
CAPACITANCE TOLERANCE	± 20 %				
LEAKAGE CURRENT	0.1 CV				
DISSIPATION FACTOR	8 % to 10 %				
ESR	6 m Ω to 500 m Ω				
CASE SIZES	J, P, A, T, B, Z, V, D, C				
TERMINATION FINISH	Cases J, P, C: 100 % tin Case A, T, B, Z, V, D: Ni / Pd / Au				

POLYMER CAPACITORS - LEADFRAMELESS MOLDED CASE					
SERIES	T52	T58	T59	T54	20021
PRODUCT IMAGE		E 1/07			
ТҮРЕ	vPolyTan TM polymer surface mount chip capacitors, low profile, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, compact, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type, hi-rel commercial off-the-shelf (COTS)	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type, DLA approved
FEATURES	Low profile	Small case size	Multianode	Hi-rel COTS, multianode	Multianode
TEMPERATURE RANGE	-55 °C to +105 °C	-55 °C to +105 °C	-55 °C to +105 °C	-55 °C to +125 °C	-55 °C to +125 °C
CAPACITANCE RANGE	47 μF to 1500 μF	1 μF to 330 μF	15 μF to 470 μF	15 μF to 470 μF (discrete capacitors) 30 μF to 2800 μF (stacked capacitors)	15 μF to 470 μF
VOLTAGE RANGE	10 V to 35 V	6.3 V to 35 V	16 V to 75 V	16 V to 75 V	16 V to 63 V
CAPACITANCE TOLERANCE	± 20 %	± 20 %	± 10 %, ± 20 %	± 20 %	± 20 %
LEAKAGE CURRENT	0.1 CV				
DISSIPATION FACTOR	10 %	8 % to 14 %	12 %	12 %	10 %
ESR	25 m Ω to 55 m Ω	50 m $Ω$ to 500 m $Ω$	25 m Ω to 150 m Ω	5 m Ω to 150 m Ω	25 m Ω to 150 m Ω
CASE SIZES	E5, M1, M9, B2	MM, W0, W9, A0, BB	EE	EE, E2, E3, E4, E6	EE
TERMINATION	100	% tin	100 % tin	Tin / lead	

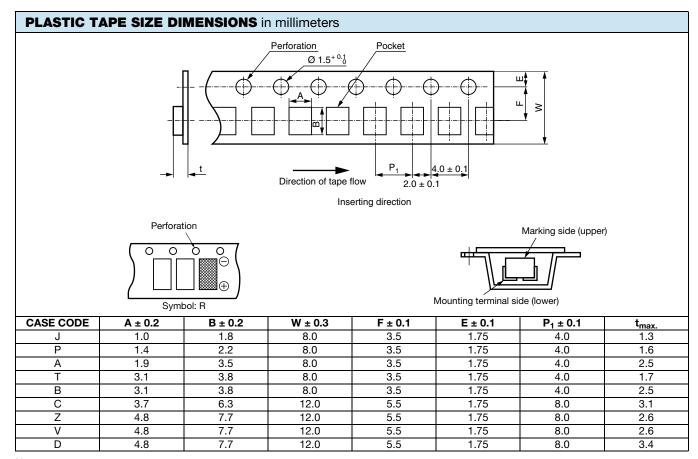


MOLDED CAPACITORS, T50 / T55 / T56 TYPES



Note

· A reel diameter of 330 mm is also applicable

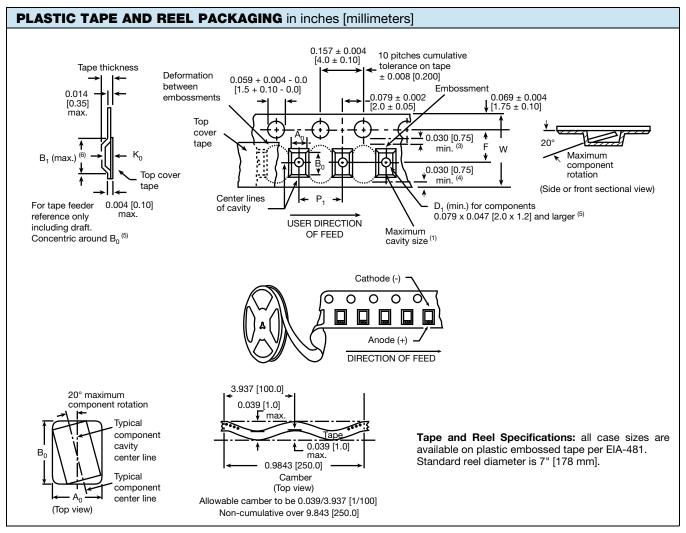


Note

A reel diameter of 330 mm is also applicable



LEADFRAMELESS MOLDED CAPACITORS, ALL TYPES



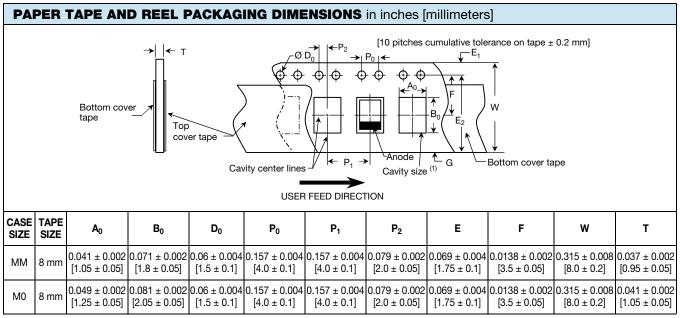
- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- (6) B₁ dimension is a reference dimension tape feeder clearance only



CARRIER TAPE DIMENSIONS in inches [millimeters]								
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	P ₂	w
E5	12 mm	0.329 [8.35]	0.059 [1.5]	0.217 ± 0.002 [5.50 ± 0.05]	0.071 [1.8]	0.315 ± 0.004 [8.0 ± 0.10]	0.079 ± 0.002 [2.00 ± 0.05]	0.476 ± 0.008 [12.1 ± 0.20]
MM ⁽²⁾	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
M1, M9	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.094 [2.39]	0.315 ± 0.04 [8.0 ± 1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
W9	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
WO	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
A0	8 mm	1	0.02 [0.5]	0.138 [3.5]	0.049 [1.25]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
ВВ	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.087 [2.22]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
EE	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.175 [4.44]	0.315 ± 0.04 [8.0 ±1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
B2	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.057 [1.45]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
D (3)	16 mm	0.321 [8.16]	0.059 [1.5]	0.295 ± 0.004 [7.50 ± 0.1]	0.308 [7.83]	0.472 ± 0.004 [12.00 ± 0.1]	0.079 ± 0.004 [2.00 ± 0.1]	0.630 ± 0.012 [16.00 ± 0.3]

Notes

- (1) For reference only
- (2) Standard packaging of MM case is with paper tape. Plastic tape is available per request
- (3) Tape thickness 0.018 [0.45] max.



Note

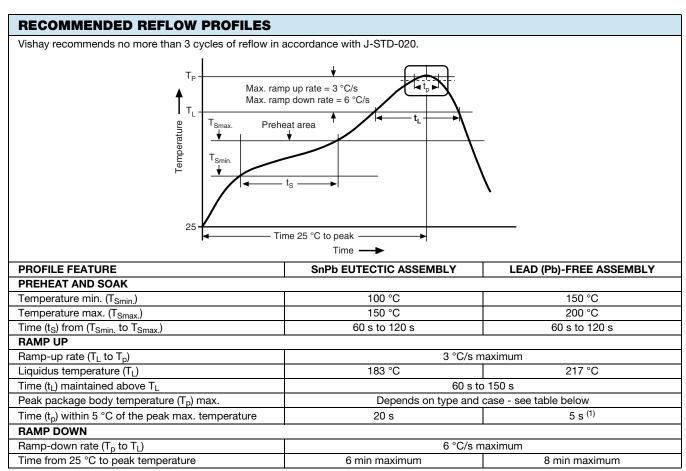
⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°



PACKING AND STORAGE

Polymer capacitors meet moisture sensitivity level rating (MSL) of 3 or 4 as specified in IPC/JEDEC® J-STD-020 and are dry packaged in moisture barrier bags (MBB) per J-STD-033. MSL for each particular family is defined in the datasheet - either in Features" section or "Standard Ratings" table. Level 3 specifies a floor life (out of bag) of 168 hours and level 4 specifies a floor life of 72 hours at 30 °C maximum and 60 % relative humidity (RH). Unused capacitors should be re-sealed in the MBB with fresh desiccant. A moisture strip (humidity indicator card) is included in the bag to assure dryness. To remove excess moisture, capacitors can be dried at 40 °C (standard "dry box" conditions).

For detailed recommendations please refer to J-STD-033.



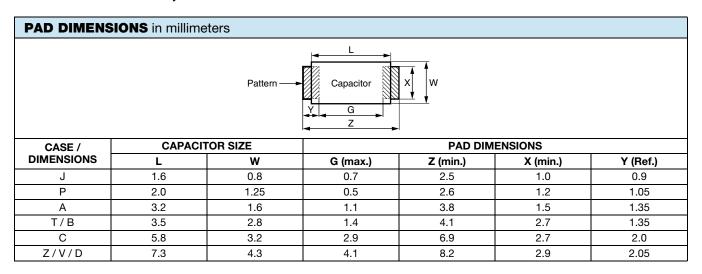
⁽¹⁾ For T27, lead (Pb)-free capacitors $t_p = 30 \text{ s}$

PEAK PACKAGE BODY TEMPERATURE (Tp) MAXIMUM					
TYPE	CASE CODE	PEAK PACKAGE BODY TEMPERATURE (T _P) MAX.			
ITPE	CASE CODE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY		
T27	D	220 °C	245 °C		
T55	J, P, A, T, B, C, Z, V, D		260 °C		
T52	E5, M1, M9, B2		260 °C		
T58	MM, M0, W9, W0, A0, BB	n/a	260 °C		
T50	D		260 °C		
T56	D		250 °C		
T59	EE	220 °C	250 °C		
T54	EE, E2, E3, E4, E6	220 °C	250 °C		
20021	EE	220 °C	n/a		

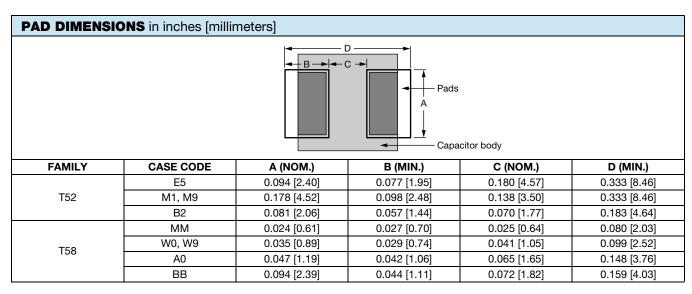
- T50, T52, T55, T56, and T58 capacitors are process sensitive. PSL classification to JEDEC J-STD-075: R4G
- T54 and T59 capacitors with 100 % tin termination are process sensitive. PSL classification to JEDEC J-STD-075: R6G



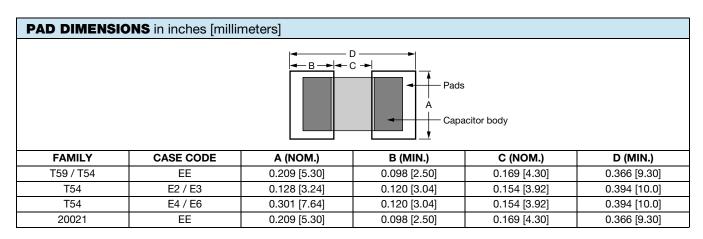
MOLDED CAPACITORS, T50 / T55 / T56 TYPES



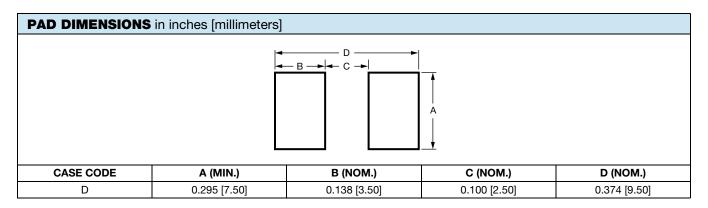
LEADFRAMELESS MOLDED CAPACITORS T52 / T58



LEADFRAMELESS MOLDED CAPACITORS T59 / T54 / 20021



HERMETICALLY SEALED CAPACITOR T27 TYPE



GUIDE TO APPLICATION

 AC Ripple Current: the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = the capacitor equivalent series resistance at the specified frequency.

2. **AC Ripple Voltage:** the maximum allowable ripple voltage shall be determined from the formula:

$$V_{\text{RMS}} \, = \, Z \sqrt{\frac{P}{R_{\text{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

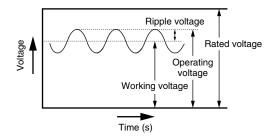
where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = The capacitor equivalent series resistance at the specified frequency.

Z = The capacitor impedance at the specified frequency.

2.1 The tantalum capacitors must be used in such a condition that the sum of the working voltage and ripple voltage peak values does not exceed the rated voltage as shown in figure below.



3. **Temperature Derating:** power dissipation is affected by the heat sinking capability of the mounting surface. If these capacitors are to be operated at temperatures above +45 °C, the permissible ripple current (or voltage) shall be calculated using the derating coefficient as shown in the table below:

MAXIMUM RIPPLE CURRENT TEMPERATURE DERATING FACTOR				
≤ 45 °C	1.0			
55 °C	0.8			
85 °C	0.6			
105 °C	0.4			
125 °C	0.25			

 Reverse Voltage: the capacitors are not intended for use with reverse voltage applied. However, they are capable of withstanding momentary reverse voltage peaks, which must not exceed the following values:

At 25 $^{\circ}\text{C}$: 10 % of the rated voltage or 1 V, whichever is smaller.

At 85 $^{\circ}$ C: 5 $^{\circ}$ of the rated voltage or 0.5 V, whichever is smaller.

At 105 °C: 3 % of the rated voltage or 0.3 V, whichever is smaller.

5. Mounting Precautions:

5.1 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering, and hot plate methods. The soldering profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.

Vishay

5.2 Limit Pressure on Capacitor Installation with Mounter: pressure must not exceed 4.9 N with a tool end diameter of 1.5 mm when applied to the capacitors using an absorber, centering tweezers, or similar (maximum permitted pressurization time: 5 s). An excessively low absorber setting position would result in not only the application of undue force to the capacitors but capacitor and other component scattering, circuit board wiring breakage, and / or cracking as well, particularly when the capacitors are mounted together with other chips having a height of 1 mm or less.

5.3 Flux Selection

- 5.3.1 Select a flux that contains a minimum of chlorine and amine.
- 5.3.2 After flux use, the chlorine and amine in the flux remain must be removed.
- 5.4 Cleaning After Mounting: the following solvents are usable when cleaning the capacitors after mounting. Never use a highly active solvent.
 - Halogen organic solvent (HCFC225, etc.)
 - Alcoholic solvent (IPA, ethanol, etc.)
 - Petroleum solvent, alkali saponifying agent, water, etc.

Circuit board cleaning must be conducted at a temperature of not higher than 50 °C and for an immersion time of not longer than 30 minutes. When an ultrasonic cleaning method is used, cleaning must be conducted at a frequency of 48 kHz or lower, at an vibrator output of 0.02 W/cm³, at a temperature of not higher than 40 °C, and for a time of 5 minutes or shorter.

- Care must be exercised in cleaning process so that the mounted capacitor will not come into contact with any cleaned object or the like or will not get rubbed by a stiff brush or similar. If such precautions are not taken particularly when the ultrasonic cleaning method is employed, terminal breakage may occur
- When performing ultrasonic cleaning under conditions other than stated above, conduct adequate advance checkout



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